



Advance Programme

# Fourth International Symposium on Acoustic Wave Devices for Future Mobile Communication Systems

Sponsored by Chiba University

## Third International Workshop on Piezo-Devices Based on Latest MEMS Technologies

Sponsored by Standardization Committee for MEMS Devices  
for Frequency Control and Selection (Chair K.Ohwada)

In collaboration with  
Japanese National Committee of TC49 in IEICE  
IEEE Ultrasonics, Ferroelectrics and Frequency Control Society Japan Chapter,  
Micromachine Center

Wednesday, 3rd - Friday, 5th March, 2010

Keyaki Hall, Chiba University, Japan

Sponsored by Chiba University

<http://echo.usl.chiba-u.ac.jp/~ken/symp2010.html>

**Wednesday, 3rd March**

### Opening Remarks

9:10

M.Yamaguchi, Chiba University  
Y.Sekine, Nihon University

### 1A Opening Talk

9:20 **Highly Flexible Digital Front-End Enhanced CMOS-Based RF Transceivers**

L.Maurer, R.Stuhlberger, C.Wicpalek, G.Haberpeuntner and G.Hueberet, DICE GMBH

### 1B Measurement Techniques for Device Characterization

10:15 **Considerations on Measurement Setup for Second-Order Nonlinearity in Radio-Frequency Bulk Acoustic Wave Duplexers**

Y.Wang, F.Thalmayr, N.Wu and K.Hashimoto, Chiba University

10:40 **Measurement of Frequency Characteristics for GHz band Crystal Resonators**

Y.Sakuta, H.Iijima, T.Imaike and Y.Sekine, Nihon University

11:05 **Phase-Sensitive and Fast-Scanning Laser Probe System for RF SAW/BAW Devices**

N.Wu, K.Hashimoto, K.Kashiwa, T.Omori and M.Yamaguchi, Chiba University

11:30 **Visualization of microacoustic waves by laser interferometry**

G.Fischerauer and A.Gollwitzer, University of Bayreuth

### 1C Quartz Resonator and Oscillators

13:10 **A Review of the Recent Development of Temperature Stable Cuts of Quartz for SAW Applications**

C.S.Lam, Epson Electronics America, Inc.

13:35 **Q, Activity Dips and Thermal Analysis of Resonators**

Y.K.Yong, Rutgers University

14:00 **Miniaturized Quartz Vibratory Gyro Sensor**

T.Kikuchi, Epson Toyocom, Co. Ltd.

14:25 **Experimental Study of CPT Based Atomic Clocks for Low-Power Operation**

S.Goka, Tokyo Metropolitan University

### 1D SAW Sensors

15:15 **Applications of Wireless Temperature Measurement using SAW Resonators**

D.Stevens<sup>1</sup>, S.Sabah<sup>1</sup>, J.Andle<sup>2</sup> and B.Wall<sup>1</sup>, <sup>1</sup>Vectron International, <sup>2</sup>SenGenuity

15:40 **Liquid-Phase SH-SAW Immunoassay Sensor**

H.Yatsuda, T.Kogai, N.Yoshimura and T.Mori, Japan Radio, Co. Ltd.

16:05 **Shear Horizontal Surface Acoustic Wave Sensors for Liquids**

J.Kondoh, Shizuoka University

16:30 **Selective Gas Detection using Polyaniline/Tungsten Oxide Nanocomposite Interfaces and Surface Acoustic Wave Sensors**

C.Y.Shen, Y.H.Cheng and S.H.Wang, I-Shou University

## **Thursday, 4th March**

### **2A Recent RF BAW Technologies**

**9:00 Progress and BreakThroughs on Coupled Resonator Filter using FBAR Technology**

R.Ruby, Avago Technologies

**9:25 RF filters for Converged Frontend Architectures in Multi-Standard Phones**

R.Aigner, Triquint Semiconductor

**9:50 Development of Radio Frequency Filters Employing Air-Gap type Thin Film Bulk Acoustic Resonators**

M.Ueda, M.Hara, T.Yokoyama, T.Sakashita, T.Nishihara and Y.Satoh, Fujitsu Laboratories

### **2B Design of RF BAW Devices**

**10:40 Progress on Zero Drift Resonators for Quartz Replacement**

R. Ruby, Avago Technologies

**11:05 Fast Evaluation of Lamb Wave Scattering by Time Harmonic FEM simulation**

F.Thalmayr, K.Hashimoto, T.Omori and M.Yamaguchi, Chiba University

**11:30 Numerical Modelling of BAW Filters and Duplexers**

S.Marksteiner, A.Link, A.Hagelauer, N.Selimovic and B.Bader, EPCOS AG

### **2C Integration of RF SAW/BAW Devices**

**13:10 Integration Concepts for SAW Duplexers for Multimode and Multiband RF Front-end Modules**

R.D.Koch<sup>1</sup>, J.E.Kiwitt<sup>1</sup>, F.M.Pitschi<sup>1</sup>, K.Wagner<sup>1</sup> and R.Weigel<sup>2</sup>,  
<sup>1</sup>EPCOS AG, <sup>2</sup>University of Erlangen-Nuremberg

**13:35 MEMS-Based Acoustic Devices for Multiband Wireless Communication**

S.Tanaka, Tohoku University

**13:50 Contour-Mode AlN Resonator with Large Coupling Factor**

A.Isobe, Hitachi Central Research Labs

**14:15 High Performance MEMS Oscillators for Communications Applications**

J.H.Kuypers, G.Zolfagharkhani, A.Gaidarzhy, R.Rebel, D.M.Chen, K.J.Schoepf,  
P.Mohanty and M.Crowley, Sand 9, Inc.

### **2D Thin Films and Processing**

**15:15 New Generation of S-Gun Magnetron for AlN Reactive Sputtering**

V.Felmetsger and P.Laptev, Tegal Corp.

**15:40 Fundamentals of Thin Film Deposition Process for Perovskite Piezoelectric Materials**

K.Wasa, Kyoto University

**16:05 Ultrasonic Micro-Spectroscopy Characterization of ZnO**

J.Kushibiki, Y.Ohashi, and M.Arakawa, Tohoku University

**16:30 Various Piezoelectric Properties of KNbO<sub>3</sub> Based Ferroelectric Ceramics**

H.Nagata, K.Hikita, Y.Hiruma and T.Takenaka, Tokyo University of Science

## **Friday, 5th March**

### **3A Extremely Wideband SAW Devices**

**9:00 Ultra wideband SAW resonator and its application to tunable filter**

Michio Kadota, Tetsuya Kimura and Yasuyuki Ida, Murata MFG Co.Ltd.

**9:25 A Wideband Multi-Mode SAW Filter Employing Pitch Modulated IDTs on Cu-Grating/15°YXLiNbO<sub>3</sub>-Substrate Structure**

K.Hashimoto, T.Miyamoto, K.Shimada, T.Omori and M.Yamaguchi, Chiba University

**9:50 A Consideration for Realizing the Tunable Ladder-type Acoustic Filter**

T.Komatsu, K.Hashimoto, T.Omori and M.Yamaguchi, Chiba University

### **3B Modern SAW Duplexers**

**10:40 Realization of Small and Low Profile Duplexer Using a CSSD Packaging Technique**

T.Nishizawa, M.Tajima, S.Ono and O.Kawachi, Fujitsu Media Devices, Ltd.

**11:05 Novel Spurious Suppression Technique of SAW Resonator on SiO<sub>2</sub>/Al/LiNbO<sub>3</sub> Structure**

H.Nakamura, H.Nakanishi, R.Goto, and T.Tsurunari, Panasonic Electronic Devices, Co. Ltd.

**11:30 Miniature Balanced SAW Duplexers using CSP Technology for UMTS and LTE**

S.Yoshimoto, T.Kawamoto, Y.Takahashi and Y.Yamamoto, Nihon Dempa Kogyo, Co. Ltd.

### **3C Quasi-SAW Devices**

**13:10 Development & Design of BIDT SAW Devices**

B.Abbott, R.Aigner, A.Chen, K.Gamble, J.Gratier, T.Kook  
and M.Solal, Triquint Semiconductor, Ltd.

**13:35 Isolated Waves as an Approach to Wafer Level Packaging**

S.Zhgoon<sup>1</sup> and K.Bhattacharjee<sup>2</sup>, <sup>1</sup>MPEI Moscow, Russia, <sup>2</sup>RFMD

**13:50 Leaky-SAW Properties on Reverse-Proton-Exchanged LiNbO<sub>3</sub>**

S.Kakio, H.Shimizu and Y.Nakagawa, University of Yamanashi

**14:15 Acoustic Wave Devices composed of Periodical Poled Z-cut LiTaO<sub>3</sub> Plate**

M.Kadota<sup>1</sup>, T.Ogami<sup>1</sup>, K.Yamamoto<sup>1</sup> and Y.Cho<sup>2</sup>, <sup>1</sup>Murata MFG Co.Ltd., <sup>2</sup>Tohoku University

### **3D New Processes for High Performance SAW/BAW Devices**

**15:15 Quantitative Raman Spectroscopy of Piezoelectric Materials and Devices**

G.Pezzotti, Kyoto Institute of Technology

**15:40 Some Issue on Preparation of Diamond Films for SAW Device Application**

I.N.Lin, Tamsui University

**16:05 Fabrication of SHF Range SAW Devices on AlN/Diamond-Substrate**

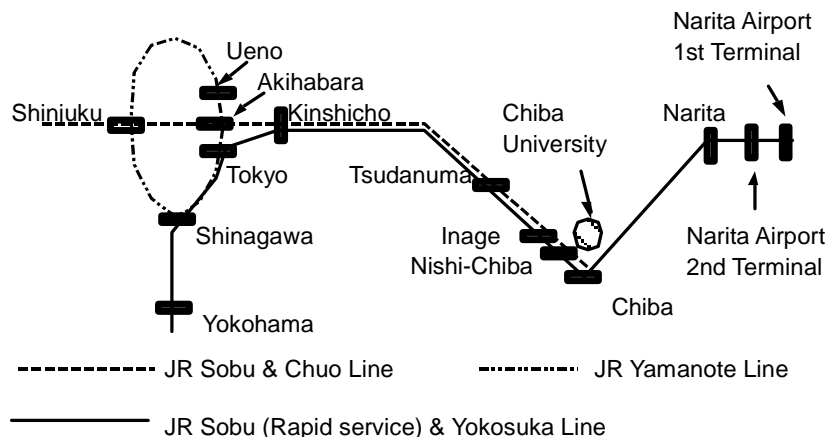
T.Omori, A.Kobayashi, Y.Takagi, K.Hashimoto and M.Yamaguchi, Chiba University

**16:30 Utilization of Phononic Reflectors in Acoustic Wave Resonators**

T.T.Wu<sup>1</sup>, J.H.Sun<sup>1</sup>, J.C.Hsu<sup>2</sup> and W.S.Wang<sup>1</sup>, <sup>1</sup>National Taiwan University,  
<sup>2</sup>National Yunlin University of Science and Technology



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**Fourth International Symposium on  
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**Form is due before  
13th February, 2010**

**Advance Registration Form**

Are you Japanese resident?  Yes  No

Last (Family) Name
First (Given) Name:
Affiliation:
Mail Stop:
Mailing Address:
Telephone:
Fax:
e-mail:

**Fax or post the Completed Form to:**

**Ms Hideko Kosami  
Symposium Secretariat  
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Graduate School of Engineering, Chiba University  
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